



BCM

Product Change Notice

PCN Type: Hardware BIOS/Firmware Package/Label Driver OS Others Page: 1 of 1

PCN Number: 70861-H1-002		Revision: A		Date of Publication: 03/05/2013
PRODUCT NAME	PRODUCT PART#	OLD — REV. — NEW		REVISION TYPE
70861-C	RX77Q	1.0	1.1	Hardware

REASON OF CHANGE:

Modify CPU heat-sink back plate retention screws to accommodate lower profile chassis enclosures such as 1U server enclosures.

DESCRIPTION OF CHANGE:

Use shorter screws on CPU back bracket.
From



*LGA 1155 and LGA 1156
Shoulder Screw for Desktop
PC, 6.00mm (.236")
Thread Length, Lead-free*



*LGA 1155 and LGA 1156
Pan Screw for Desktop PC,
6.35mm (.250")
Thread Length, Lead-free*

To



*LGA 1155 and LGA 1156
Shoulder Screw for 1U
Server, 3.80mm (.150")
Thread Length, Lead-free*



*LGA 1155 and LGA 1156
Pan Screw for 1U Server,
5.17mm (.204")
Thread Length, Lead-free*

IMPACT OF CHANGE AND RECOMMEND ACTION:

This change has been thoroughly evaluated to ensure that there are no quality, reliability, functional, or driver implications to our customers.

BCM is not recommending the customers to perform additional qualification of these changes.

AFFECTED BY THIS CHANGE	
Specification	NO
Packaging	NO
Labeling	NO
BIOS	NO
Driver	NO
Hardware	YES

CUT IN DATE:

Date: 05/20/2013

OR

Lot#:

*Cut in date is based on the current forecast.

Parts Disposition	Rework	As Is	Scrap
New Order		X	
In Process		X	
Finished Goods		X	
RMA		X	

This PCN had been **QUALIFIED** and **APPROVED** by BCM Engineering Department on 01/03/2013.

APPROVED BY

CUSTOMER/ VP OF SALES	<APPROVED>	03/05/2013
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Signature

Date